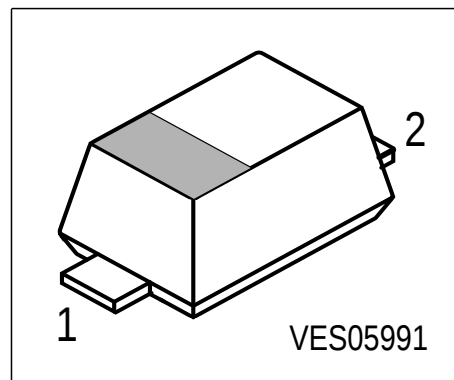


Silicon Switching Diode

Preliminary data

- For high-speed switching applications



Type	Marking	Ordering Code	Pin Configuration		Package
BAS 16-02W	3	Q62702-A1239	1 = A	2 = C	SCD-80

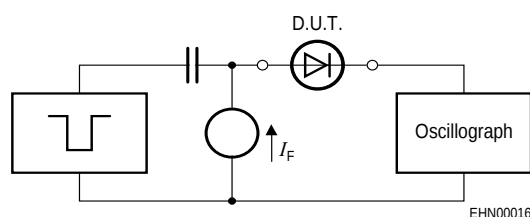
Maximum Ratings

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	75	V
Peak reverse voltage	V_{RM}	85	
Forward current	I_F	250	mA
Surge forward current, $t = 1 \mu s$	I_{FS}	2.5	A
Total power dissipation, $T_S = 119^\circ C$	P_{tot}	100	mW
Junction temperature	T_j	150	$^\circ C$
Storage temperature	T_{stg}	- 65 ...+150	

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC characteristics					
Breakdown voltage $I_{(BR)} = 100\ \mu\text{A}$	$V_{(BR)}$	75	-	-	V
Forward voltage $I_F = 1\ \text{mA}$ $I_F = 10\ \text{mA}$ $I_F = 50\ \text{mA}$ $I_F = 150\ \text{mA}$	V_F	- - - -	- - - -	715 855 1000 1250	mV
Reverse current $V_R = 70\ \text{V}$	I_R	-	-	1	μA
Reverse current $V_R = 25\ \text{V}, T_A = 150\ ^\circ\text{C}$ $V_R = 75\ \text{V}, T_A = 150\ ^\circ\text{C}$	I_R	- -	- -	30 50	nA
Forward recovery voltage $I_F = 10\ \text{mA}, t_p = 20\ \text{ns}$	V_{fr}	-	-	1.75	V
AC characteristics					
Diode capacitance $V_R = 0\ \text{V}, f = 20\ \text{MHz}$	C_D	-	-	2	pF
Reverse recovery time $I_F = 10\ \text{mA}, I_R = 10\ \text{mA}, R_L = 100\ \Omega$, measured at $I_R = 1\text{mA}$	t_{rr}	-	-	6	ns

Test circuit for reverse recovery time

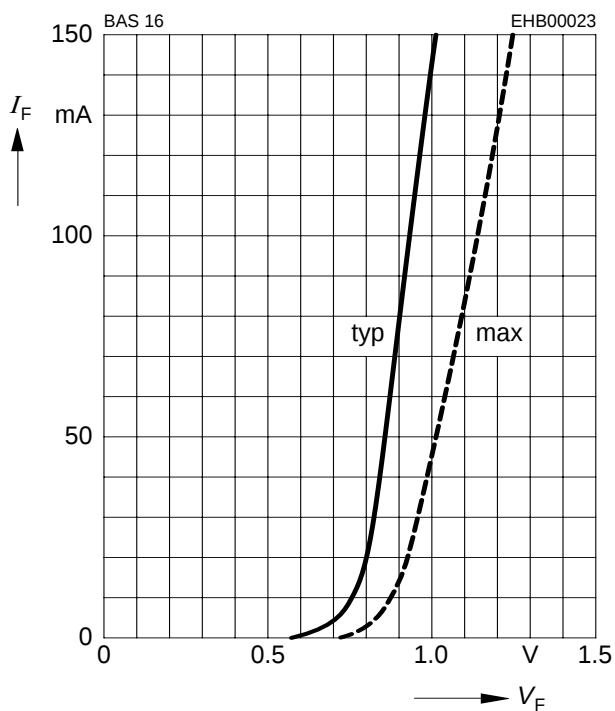


Pulse generator: $t_p = 100\text{ns}$, $D = 0.05$,
 $t_r = 0.6\text{ns}$, $R_i = 50\Omega$

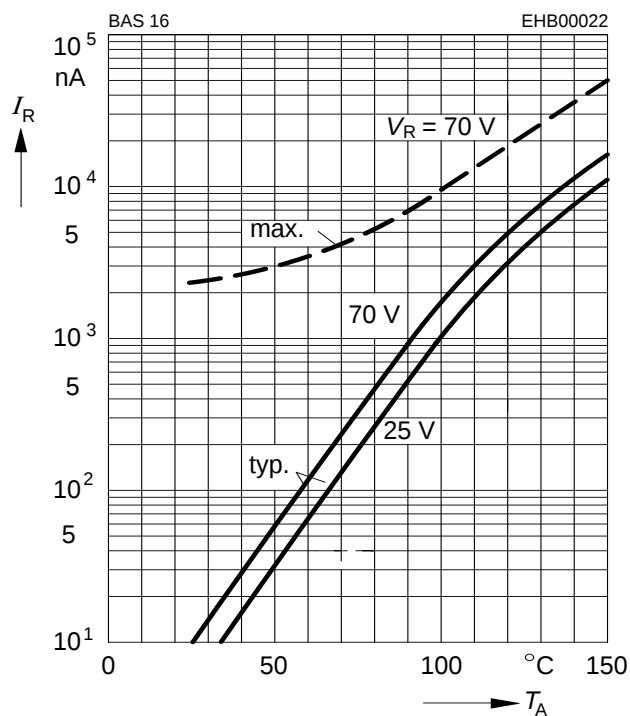
Oscilloscope: $R = 50\Omega$, $t_r = 0.35\text{ns}$,
 $C \leq 1\text{pF}$

Forward current $I_F = f(V_F)$

$T_A = 25^\circ\text{C}$



Reverse current $I_R = f(T_A)$



Forward voltage $V_F = f(T_A)$

